Termination Control of the Interfa
e Dipole in $\text{La}_{0.7}\text{Sr}_{0.3}\text{MnO}_3/\text{Nb:SrTiO}_3$ (001) Schottky Junctions

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Abstra
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In order to investigate the interfa
e termination dependen
e of perovskite band alignments, we have studied the Schottky barrier height at $\text{La}_{0.7}\text{Sr}_{0.3}\text{MnO}_3/\text{Nb}\cdot\text{SrTiO}_3$ (001) heterointerfaces. As the Nb:SrTiO₃ semiconductor was varied from TiO₂ termination to SrO termination by variable insertion of a SrMnO₃ layer, a large systematic increase in the Schottky barrier height was observed. This an be as
ribed to the evolution of the interfa
e dipole indu
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reen the polar dis
ontinuity at the interfa
e, whi
h gives a large internal degree of freedom for tuning band diagrams in oxides.

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FIG. 1: (Color online) The two different possible interfaces between the perovskites $\text{La}_{0.7}\text{Sr}_{0.3}\text{MnO}_3$ and SrTiO₃ joined in the [001] direction: (a) TiO₂-terminated, and (b) SrO-terminated SrTiO₃.

There has been burgeoning recent interest in the electronic structure of complex oxide heterointerfaces. Technical advances in oxide thin film growth allow the fabrication of structures with atomic scale precision, and together with theoretical advances, a host of new interface electronic states have been found and/or predicted [\[1,](#page-8-0) [2](#page-8-1), [3,](#page-8-2) [4](#page-8-3), [5,](#page-8-4) [6](#page-8-5), [7,](#page-8-6) [8](#page-8-7), 9]. Fundamental to this endeavor is knowledge of band lineups, which is crucial for the design of new interface states [4], as well as the engineering of oxide devices. Compared to conventional semiconductors and metals, however, oxide heterointerfaces are far less understood [10].

In addition to improving the basic knowledge of complex oxide work functions, electron affinities, etc., there are also structural degrees of freedom at their interfaces which have been little explored. For example, the heterointerfa
e between two (001)-oriented perovskites with different cations can have two different interface terminations (Fig. [1\)](#page-1-0). Given the partially ionic nature of oxides, the different terminations could have significantly different interface dipoles, thus changing the band lineup across the interface. In order to experimentally investigate this effect, we have studied the Schottky interface between the ferromagnetic metal $\text{La}_{0.7}\text{Sr}_{0.3}\text{MnO}_3$ and the *n*-type semiconductor Nb-doped SrTiO₃ (0.05 wt % doped). In addition to providing a model system for these studies, this interfa
e is of strong interest in magnetic tunnel junctions [\[11](#page-8-10)], magnetic field sensitive diodes $[12]$ $[12]$, and for enhanced photocarrier injection [\[13](#page-8-12)].

In this paper, we report the investigation of the Schottky barrier height (SBH) in (001)oriented $\rm La_{0.7}Sr_{0.3}MnO_3/Nb:SrTiO_3$ Schottky junctions as 0 - 1 unit cell (uc) of $\rm SrMnO_3$ is inserted at the interface. By growing a $La_{0.7}Sr_{0.3}MnO_3$ film directly on TiO₂-terminated

Nb:SrTiO₃, a MnO₂/La_{0.7}Sr_{0.3}O/TiO₂ interface is formed [Fig. [1\(](#page-1-0)a)]. Alternatively, by first growing 1 uc of $SrMnO₃$ before $La_{0.7}Sr_{0.3}MnO₃$ deposition, the $MnO₂/SrO/TiO₂$ interface is formed [Fig. [1\(](#page-1-0)b)], which is equivalent to the deposition of $La_{0.7}Sr_{0.3}MnO_3$ on the alternative SrO-terminated $Nb:STIO₃$ surface [14]. The deposition of a fractional unit cell of SrMnO₃ allows the study of the evolution of the SBH between these endpoints, which was probed using current-voltage $(I-V)$, capacitance-voltage $(C-V)$, and internal photoemission (IPE) measurements. All experiments indi
ate a systemati in
rease in the SBH by hanging the termination layer at the interface. Although this result is difficult to understand within a Schottky-Mott $|15|$ or Bardeen $|16|$ framework for metal-semiconductor interfaces, a simple onsideration of the evolution of the s
reening dipole at the interfa
e explains this trend, whi
h is expe
ted to be quite general for metal-semi
ondu
tor and metal-insulator perovskite heterointerfa
es.

The heterojunctions were fabricated by pulsed laser deposition using a KrF excimer laser with a laser fluence of 0.22 J/cm², substrate temperature of 850 °C, and an oxygen partial pressure of 1×10^{-3} Torr, as previously optimized [17]. The interface termination was varied by deposition of a calculated thickness of $SrMnO₃$ ($SrMnO₃ = 0.0, 0.3, 0.6, 1.0$ uc), for which the deposition rate was calibrated with reflection high energy electron diffraction (RHEED) prior to the fabrication of the final structures. After the deposition of SrMnO_3 , 100 uc of $\text{La}_{0.7}\text{Sr}_{0.3}\text{MnO}_3$ was deposited by monitoring the RHEED oscillations. Temperature dependent magnetization measurements give Curie temperatures $T_C \sim 360$ K in all cases. Ohmic contacts to the $\text{La}_{0.7}\text{Sr}_{0.3}\text{MnO}_3$ and the Nb:SrTiO₃ were made by evaporated gold films and In ultrasonic soldering, respectively, contacting an array of junctions each ~ 0.25 mm² in area. All the measurements were carried out at room temperature and the polarity of the applied bias is defined as positive when applied to the $La_{0.7}Sr_{0.3}MnO_3$.

Figure $2(a)$ $2(a)$ shows typical *I-V* characteristics on a semi-logarithmic scale for samples with different $SrMnO₃$ coverage. Clear rectifying behavior was observed in all cases with forward biased current density systematically decreasing with increase in SrMnO₃ coverage. The barrier height obtained from the *I*-*V* characteristics (Φ_{SB}^{IV}) was calculated based on thermoionic emission by fitting the forward biased region of the $I-V$ characteristics. Here a Richardson constant of 156 AK⁻² was used [\[18](#page-8-17)]. In order to obtain reliable statistics, 12 - 19 jun
tions were sampled for ea
h omposition. The obtained SBHs are summarized in a histogram shown in Fig. [2\(](#page-3-0)b) from which it is apparent that an increase in the SBH

FIG. 2: (Color online) (a) Current-voltage and (c) capacitance-voltage characteristics of $\text{La}_{0.7}\text{Sr}_{0.3}\text{MnO}_3/(\text{SrMnO}_3)_x/\text{Nb:SrTiO}_3$ junctions at room temperature for different interface compositions. (b), (d) Histograms of the obtained SBH and V_{bi} from (a) and (c) in steps of 0.04 V normalized by the total number of measurements. The curves show best Gaussian fits.

is observed as a function of $SrMnO_3$ coverage. Considering the exponential dependence of the current on the SBH, the increase in the barrier height is consistent with the systematic decrease in the forward biased current shown in Fig. [2\(](#page-3-0)a).

The reverse biased junction capacitance characteristics at 1 kHz are presented in a $1/C^2$ -V plot as shown in Fig. $2(c)$ $2(c)$. No frequency dependence was found for the capacitance from 20 Hz - 10 kHz, above which the junction RC roll-off was observed. All samples showed a linear dependence on the applied voltage, from which the built-in potential (V_{bi}) was calcu-lated, as summarized in a histogram shown in Fig. [2\(](#page-3-0)d). The variance in V_{bi} is smaller than that in Φ_{SB}^{IV} , which is a reasonable consequence of the difference in measurement technique. The charge modulation at the edge of the depletion region far away from the interface in $C-V$ tends to capture the spatial average of the barrier height, whereas in $I-V$ the carriers surmount the interfa
e barrier, making it more sensitive to the spatial distribution of the potential at the interfa
e.

Based on these results, IPE was measured directly through the $\text{La}_{0.7}\text{Sr}_{0.3}\text{MnO}_3$ film (the

FIG. 3: (Color online) (a) Schematic illustration of internal photoemission (IPE). The electrons surmounting the barrier height are dete
ted as photo
urrent. (b) IPE spe
tra of $\text{La}_{0.7}\text{Sr}_{0.3}\text{MnO}_3/(\text{SrMnO}_3)_x/\text{Nb:SrTiO}_3$ junctions at room temperature. The square root of the photoyield is plotted against the photon energy.

Au film and electrode was mounted at the edge of the junction for each composition as shown in Fig. [3.](#page-4-0) The details of the experimental configuration have been given previously [\[19](#page-8-18)]. The square root of the photoyield \sqrt{Y} , the photocurrent normalized by the incident photon count, is plotted against the incident photon energy. All samples exhibited a linear response of $\sqrt{Y},$ justifying the application of Fowler's equation to the emission process $[20],$ from which the barrier height Φ_{SB}^{IPE} is extrapolated.

The SBHs obtained from the three independent measurements are summarized in Fig. [4.](#page-5-0) For $I-V$ and $C-V$, the mean values obtained from the Gaussian fits to the histograms were used. Note that the barrier heights extracted from V_{bi} determined by $C-V$ measurements Φ^{CV}_{SB} have been corrected for the energy difference between the conduction band minimum and the Fermi level in the $Nb:SrTiO₃$ as discussed in Ref. [\[19](#page-8-18)], which is a small correction here (~ 8.1 mV). All measurements exhibit a systematic increase in the SBH as a function of SrMnO₃ coverage at the interface. Although Φ_{SB}^{IV} commonly underestimates the SBH due to tunneling contributions or barrier inhomogeneities, the large discrepancy between Φ^{CV}_{SB} and Φ^{IPE}_{SB} is in contrast to the close correspondence of these measurements found for $SrRuO₃/Nb: SrTiO₃ junctions [19].$ $SrRuO₃/Nb: SrTiO₃ junctions [19].$ $SrRuO₃/Nb: SrTiO₃ junctions [19].$ A similar contrast between $La_{0.6}Sr_{0.4}MnO₃/Nb: SrTiO₃$ and $\rm SrRuO_3/Nb: SrTiO_3$ interfaces was observed using photoemission spectroscopy [21]. For our data, the lack of a low-frequency dispersion to the capacitance indicates that we are not dominated by low-lying trap states. Nevertheless, the quantitative difference between Φ_{SB}^{CV}

FIG. 4: (Color online) Summary of the obtained barrier heights from $I-V$ (AZ, red), $C-V$ (A \ddot{a} , blue), and IPE $(A \in \mathcal{A})$ measurements. The dotted line (green) indicates the variation of the screening dipole in a simple ionic model (see text for details).

and Φ_{SB}^{IPE} indicates the presence of fluctuating dipoles at the interface. We turn now to consider the origin of these dipoles, and the systematic increase in the SBH.

First we onsider established semi
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tor models for S
hottky barrier formation. In the simplest S
hottky-Mott model of a metal-semi
ondu
tor jun
tion, the SBH is purely determined by the difference in the work function of the metal (Φ_M) and the electron affinity (χ) of the semiconductor [\[15](#page-8-14)], and hence cannot capture any termination dependence of the SBH. The classical Fermi level pinning mechanism based on the surface states of semicon-ductors proposed by Bardeen [\[16](#page-8-15)] does not capture variations in metal screening discussed below. Recently, a bond polarization model has been developed [22], which incorporates both bulk and interface contributions. The interface specific properties are incorporated by electric dipoles generated by the abrupt break in the periodicity of the crystal potential. For an interface between a metal and an *n*-type semiconductor, the SBH is expressed as $[22]$.

$$
\Phi_{SB} = \gamma_B \left(\Phi_M - \chi \right) + (1 - \gamma_B) \frac{E_g}{2},\tag{1}
$$

where

$$
\gamma_B = 1 - \frac{q^2 N_B d_{MS}}{\epsilon_{it} \left(E_g + \kappa \right)}.\tag{2}
$$

Here E_g is the semiconductor band-gap, N_B the number of interface metal-semiconductor bonds (dipoles), d_{MS} the metal-semiconductor bonding distance, ϵ_{it} the dielectric constant at the interface, κ the specific Coulomb interaction between the neighboring atoms at the

FIG. 5: (Color online) (a) A schematic diagram of the $\text{La}_{0.7}\text{Sr}_{0.3}\text{MnO}_3/\text{Nb:SrTiO}_3$ interface charge sheet density and the electrostatic potential for 0.0 uc (left) and 1.0 uc (right) of SrMnO₃ coverage. The small arrows in $La_{0.7}Sr_{0.3}MnO_3$ represent the compensation charges induced to screen the interface. The relative electrostatic potential across the interface varies depending on the interface termination, onsequently hanging the band alignment (b) at the interfa
e (see text for details).

interface, and q the electronic charge. Given that the possible range of d_{MS} is too small to account for the shifts we have observed, N_B is the only parameter linearly varying the SBH, and it is reasonable to conclude that the dipole density at the interface, or the strength of the interface dipole, decreased with $SrMnO₃$ coverage. The limitation of the bond polarization model for our purposes is that it was established for application to covalent semiconductor interfaces, in which the concept of a number of "chemical bonds" at the interface is justified. However, for more ionic semiconductors, such as the case here, the concept of chemical bonds be
omes ambiguous be
ause the ohesion of the latti
e is dominated by the Madelung energy in the whole crystal rather than local atomic bonds. We discuss below one possible picture of the interface dipole by considering the polarity mismatch at the interface.

Because the present interface systematically changes from $MnO_2/La_{0.7}Sr_{0.3}O/TiO_2$ to $\rm MnO_2/SrO/TiO_2,$ the sheet charge density shifts from -0.7q / +0.7q / 0q to -0.7q / 0q / $0q$, assuming a fully ionic charge assignment using the nominal bulk valence for each grown layer, creating a polar discontinuity at the interface. In order to avoid a diverging electrostatic potential arising from the interface, $-/+0.35q$ extra charge is required at the two interfaces, respectively. Whereas previous considerations of this effect between two insulators were discussed in terms of electronic reconstructions $\begin{bmatrix} 1, 2, 3, 4, 5, 7, 8 \end{bmatrix}$ $\begin{bmatrix} 1, 2, 3, 4, 5, 7, 8 \end{bmatrix}$ $\begin{bmatrix} 1, 2, 3, 4, 5, 7, 8 \end{bmatrix}$ $\begin{bmatrix} 1, 2, 3, 4, 5, 7, 8 \end{bmatrix}$ $\begin{bmatrix} 1, 2, 3, 4, 5, 7, 8 \end{bmatrix}$ $\begin{bmatrix} 1, 2, 3, 4, 5, 7, 8 \end{bmatrix}$ $\begin{bmatrix} 1, 2, 3, 4, 5, 7, 8 \end{bmatrix}$ $\begin{bmatrix} 1, 2, 3, 4, 5, 7, 8 \end{bmatrix}$ $\begin{bmatrix} 1, 2, 3, 4, 5, 7, 8 \end{bmatrix}$ $\begin{bmatrix} 1, 2, 3, 4, 5, 7, 8 \end{bmatrix}$ $\begin{bmatrix} 1, 2, 3, 4, 5, 7, 8 \end{bmatrix}$, here the interface between a metal and a semiconductor is better framed in terms of metallic screening by the $\text{La}_{0.7}\text{Sr}_{0.3}\text{MnO}_3$ — the Nb:SrTiO₃ side of the interface being fully depleted.

To estimate the length scale for screening, the Thomas-Fermi screening length is ~ 0.31 nm, using a bulk carrier density of 5.1×10^{21} cm⁻³, a dielectric constant ϵ of 30 [23], and an electron effective mass of 2.5 [\[24](#page-9-2)]. This length scale, less than a unit cell, corresponds to changing the valence of Mn at the first interface layer in the simplest ionic assignment. Thus, as depicted in Fig. [5,](#page-6-0) the first MnO_2 layer of $La_{0.7}Sr_{0.3}MnO_3$ will have extra screening charge. Even after this charge compensation, a finite electrostatic potential remains inside $\text{La}_{0.7}\text{Sr}_{0.3}\text{MnO}_3$ relative to Nb:SrTiO₃, giving an interface dipole which linearly varies with the interfa
e termination.

The variation in the band-offset induced by the difference in the termination at the interfa
e an be estimated using the harge assignment shown in Fig. [5.](#page-6-0) Using the previous values used for the Thomas-Fermi estimate, the evolution of the SBH arising from this ioni dipole is given in Fig. [4,](#page-5-0) referenced to the Schottky-Mott relation $|21|$. The electrostatic potential difference between the two end-member interfaces is 0.54 V. This value, as well as the linearly in
reasing SBH with varying interfa
e termination, are in reasonable agreement with the experimentally determined trends.

In summary, we have presented experiments finding a systematic increase in the Schottky barrier height in $\text{La}_{0.7}\text{Sr}_{0.3}\text{MnO}_3/\text{Nb:SrTiO}_3$ (001) heterojunctions as the Nb:SrTiO₃ semiconductor was varied from TiO₂ termination to SrO termination, and a simple model for interface dipole formation which captures this trend. It should be noted that the ionic limit discussed here is just as oversimplified as the covalent limit used in the bond polarization model; the real system is intermediate between these two extremes. In addition to hybridization effects, a more realistic estimate of the interface dipole requires better understanding of the relevant ϵ on these very short length scales. Ab initio calculations such as re
ently performed for ultrathin perovskite superlatti
es should give more quantitative insight [\[25,](#page-9-3) [26](#page-9-4)]. Nevertheless, this basic framework for interface dipole formation is quite general, and should assist in the design of oxide heterostru
tures and ontrol of their band alignments.

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